SPECIFICATIONS

ELECTRICAL:

CURRENT RATING: 1.5AMPS
VOLTAGE RATING: 125VAC
INSULATION RESISTANCE: >1000M C

INSULATION RESISTANCE: >1000M OHMS
WITHSTANDING VOLTAGE: AC 1000V 50 OR 60HZ 1MIN

CONTACT RESISTANCE: <30 MOHMS

OPERATING TEMPERATURE: -40°C TO +85°C

STORAGE TEMPERATURE: -40°C TO +85°C

INFLAMMABILITY COMPLIANCE: 94V-0 ENVIRONMENTAL: FLC68 WAVE SOLDERING TEMP.: 265°C+/-5

MECHANICAL

MATING FORCE: 5-25N RETENTION STRENGTH: ≥ 76N

DURABILITY: ≥750CYCLE

MATERIAL

HOUSING: LCP FILLED WITH FIBERGLASS INSIDE CHIP: LCP FILLED WITH FIBERGLASS

TERMINAL PARTS UNDERPLATING: 30U MIN NICKEL OVERALL.

RJ TERMINAL: PH. BRONZE, THICKNESS: 0.3MM

FINISH: Fu GOLDEN PLATING IN CONTACT AREA

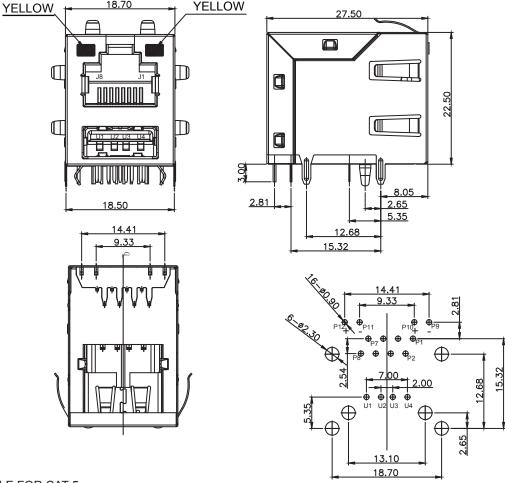
INPUT TERMINAL: BRASS THICKNESS: 0.3MM

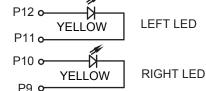
FINISH: 100U INCH MIN TIN

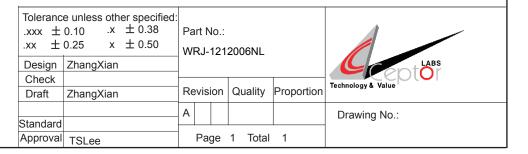
SHIELD: 0.2MM COPPER ZINC ALLOY (7440-50-80) WITH NICKEL PLATED.

USB 2.0

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F. SUITABLE FOR CAT 5e







SUGGESTED PCB LAYOUT





